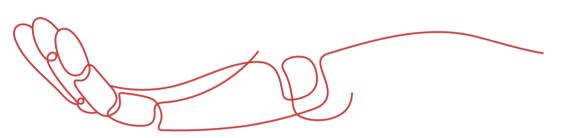


## PRODUCT DATA SHEET



To learn more about JGSEMI, please visit our website at







Datasheet

esources

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO\_questions@jgsemi.com.



2-Line Ultra Low Capacitance TVS Diode Array

### **Features**

Ultra low leakage: nA level

Operating voltage: 5V

• Ultra low capacitance:0.3pF typical

Low clamping voltage

• Complies with following standards:

- IEC 61000-4-2 (ESD) immunity test

Air discharge: ±25kV Contact discharge: ±20kV

- IEC61000-4-4 (EFT) 40A (5/50ns)

- IEC61000-4-5 (Lightning) 5A (8/20µs)

RoHS Compliant

# **Applications**

- USB 3.0 line
- HDMI1.4 Set-top box and digital TV
- 10/100/1000 Ethernet
- Notebook Computers
- SATA Ports
- MDDI Ports

### **Mechanical Characteristics**

Package: DFN1610-6

Lead Finish: Lead Free

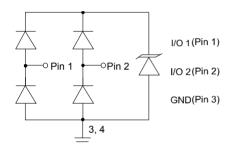
UL Flammability Classification Rating 94V-0

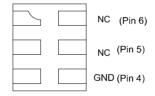
Quantity Per Reel:3,000pcs

Reel Size:7inch



**DFN1610-6** 





# **Absolute Maximum Ratings**(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20µs)	Ррр	75	W	
ESD per IEC 61000-4-2 (Air)	- V <sub>ESD</sub>	±25	Kv	
ESD per IEC 61000-4-2 (Contact)	VESD	±20		
Operating Temperature Range	TJ	-55 to +125	$^{\circ}$	
Storage Temperature Range	Тѕтл	-55 to +150	${\mathbb C}$	

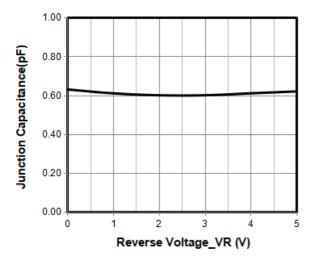


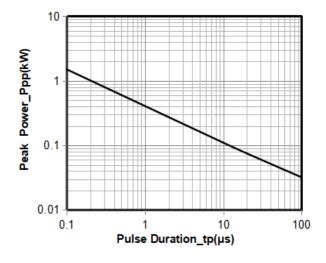
# Electrical Characteristics (TA=25°C unless otherwise specified)

	$V_{\sf RWM}$	$V_{BR}$	Iτ	Iт Vc mA) @1A	Vc		l <sub>R</sub>	С
Part Number	(V)		(mA)		(Max)	(@A)	μΑ (Max)	(Pf) (Typ.)
RCLAMP0522P	5	6	1	10	15	5	0.5	0.3

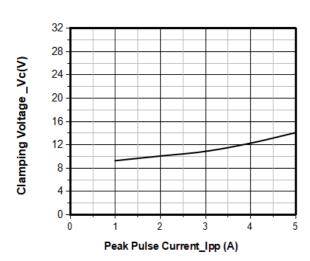


### Typical Performance Characteristics (T<sub>A</sub>=25°C unless otherwise Specified)

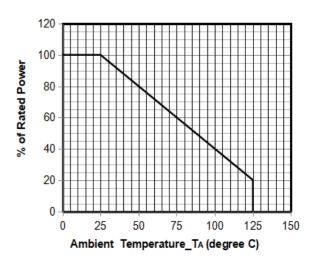




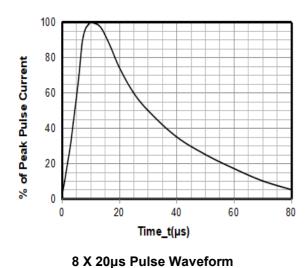
Junction Capacitance vs. Reverse Voltage



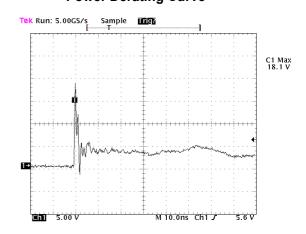
Peak Pulse Power vs. Pulse Time



### Clamping Voltage vs. Peak Pulse Current



**Power Derating Curve** 



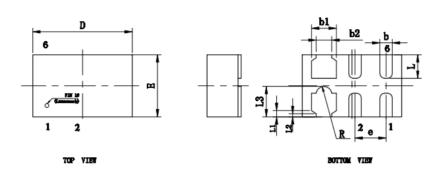
Note: Data is taken with a 10x attenuator ESD Clamping Voltage

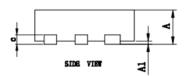
8 kV Contact per IEC61000-4-2

Ver.1.0



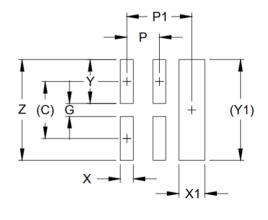
## **DFN1610-6 Package Outline Drawing**





	MILLIMETERS			
SYM	MIN	NOM	MAX	
Α	0.50	0.55	0.60	
A1		0.02	0.05	
b	0.15	0.20	0.25	
b1	0.35	0.40	0.45	
b2	0.20	0.25	0.30	
С	0.10	0.15	0.20	
D	1.55	1.60	1.65	
Е	0.95	1.00	1.05	
е	0.50BSC			
L	0.33	0.38	0.43	
L1	0.100REF			
L2	0.05REF			
L3	0.49REF			
R	0.08 0.13 0.18			

## **Suggested Land Pattern**



	DIMENSIONS		
DIM	INCHES MILLIMETERS		
С	(.034)	(0.87)	
G	.007	0.19	
Р	.020	0.50	
P1	.039	1.00	
X	.008	0.20	
X1	.016	0.40	
Υ	.027	0.68	
Y1	(.061)	(1.55)	
Z	.061	1.55	



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